

INVITATION TO NATIONAL COMPETITIVE BID
For the Procurement of Mini Fusion Splicing Machine

Floating Date: As of July 10, 2018
Closing Date: August 2, 2018
RFQ No. 3631277-2

REQUIREMENTS:

1. Ethio telecom intends to sign a Master Frame Agreement (MFA) contract for one (1) year with a possibility of extension up to a maximum of 3 years with the finally awarded bidder(s). Hence, ethio telecom invites all interested and eligible bidders by this **National Competitive Bid (NCB)** for the procurement of **Mini Fusion Splicing Machine with RFQ No. 3631277-2**. The Tender remains floating from **July 10, 2018 to August 2, 2018**.

No	Description of Items	Unit	Initial forecast order Qty.	RFQ No.
1	Mini Fusion Splicing	pcs	30	3631277-2

Bid documents can be obtained from ethio telecom's Head Office, Room No. 206 during office hours upon payment of a non-refundable fee of Birr **50.00 (Birr Fifty only)**.

2. Interested bidders are expected to fulfill the requirements stated here below:
 - a. Bid Security;
 - b. Availability of Letter of Authorization to sign the bid offers;
 - c. Anti-bribery pledge form;
 - d. Bidders should have a valid and renewed trade license for the year;
 - e. Bidders should be VAT registered;
 - f. Sample for the Min-Fusion splicer with its full accessories is required.
3. All Bids must be accompanied by a bid security in the amount of **Birr 50,000.00 (fifty Thousand only)**
4. The bid bond shall be furnished in one of the following forms: -
 - a) Certified Cheque /CPO issued by a recognized domestic bank or
 - b) Bond issued by and/or confirmed through a recognized/reputable domestic bank.
 - 4.1. The Bank that issues the bond as per 3.1 (b)

- 4.2. Here above shall **unequivocally guarantee to pay the purchaser immediately upon the first written demand of payment**. The Purchaser's written demand of payment shall not be subject to any condition whatsoever.
- 4.3. The bond issuing bank shall clearly incorporate the content stated under Clause here above on the issued bond.
- 4.4. Sealed bids marked as: "Tender for the Supply of **Mini Fusion Splicing Machine with (RFQ No. 3631277-2)** and be addressed to:

**Ethio telecom
Churchill Road
Head Quarter
Sourcing and Facilities Division
2nd Floor, Room No. 214
P. O. Box: 1047, Addis Ababa, Ethiopia**

5. Bid proposal will be received at the **Churchill Road, Head Quarter 2nd Floor, Room No. 214, before or on August 2, 2018 until 5:00 P.M.** Bids presented by any bidder after the closing date shall not be accepted.
6. Bids received in time and fulfilling the other formalities shall be opened in the presence of interested bidders or their legal representatives **on August 3, 2018 at 10:00 A.M, at Churchill Road, Head Quarter 2nd Floor, Room No. 210.**
7. Partial bid is not allowed.
8. No one is allowed to duplicate or transfer the bidding document that she/he acquired to participate under this invitation.
9. Bidders are seriously advised to read and comply with the instructions provided in this bidding document.
10. Ethio telecom reserves the right to reject all or parts of this bid.